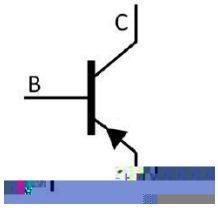
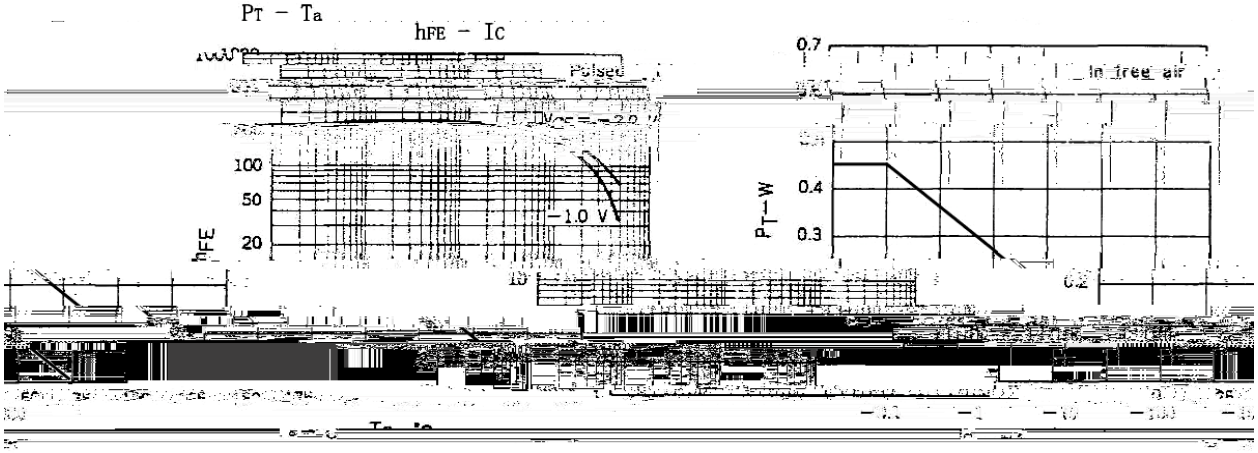
SOT-23 PNP

,h_{FE} ,V_{CEO}

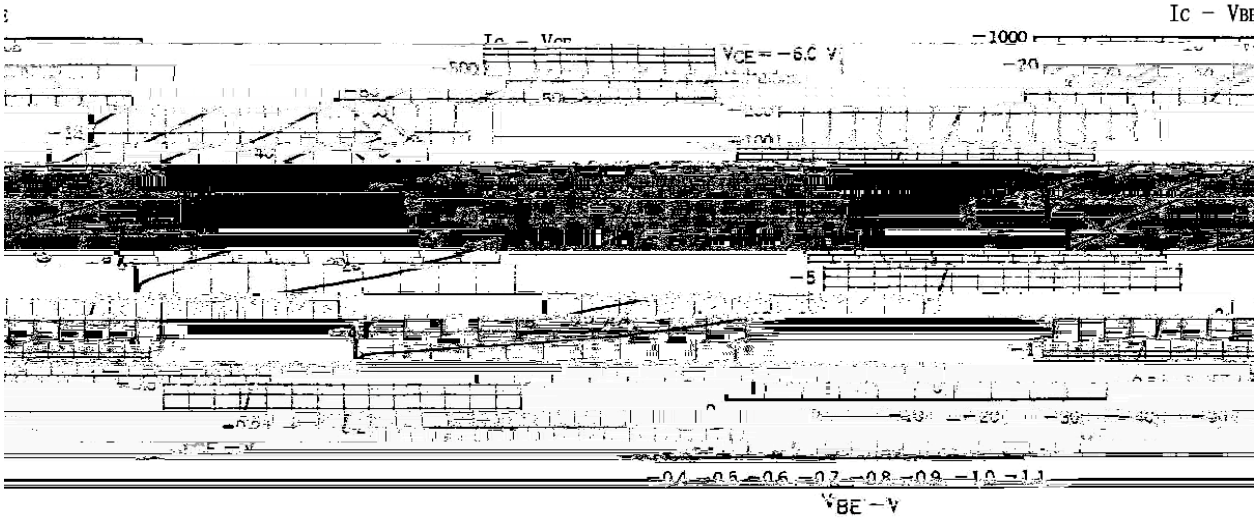


P_T – T_a



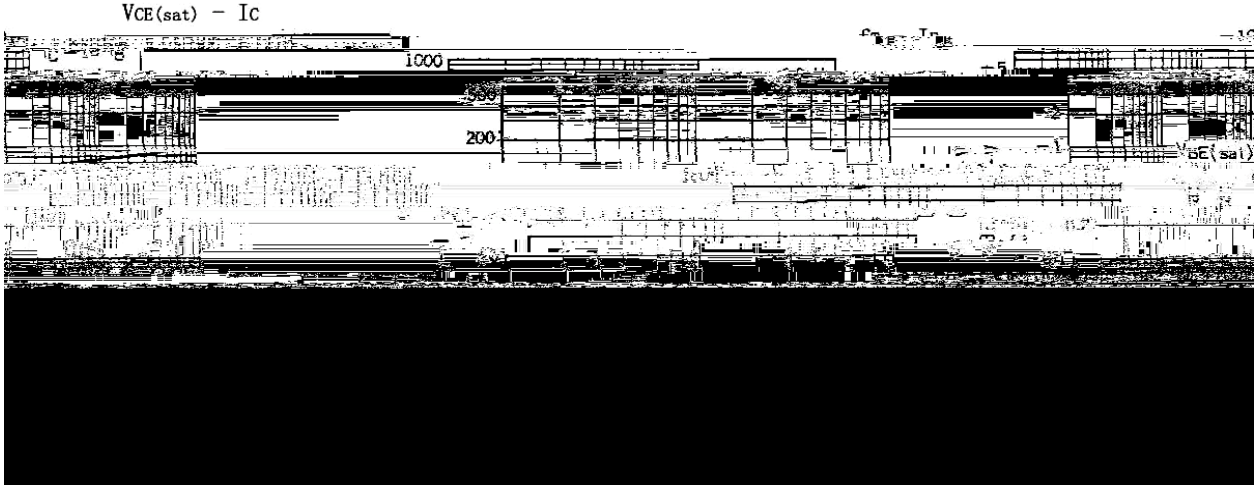
h_{FE} – I_C

I_C – V_{BE}



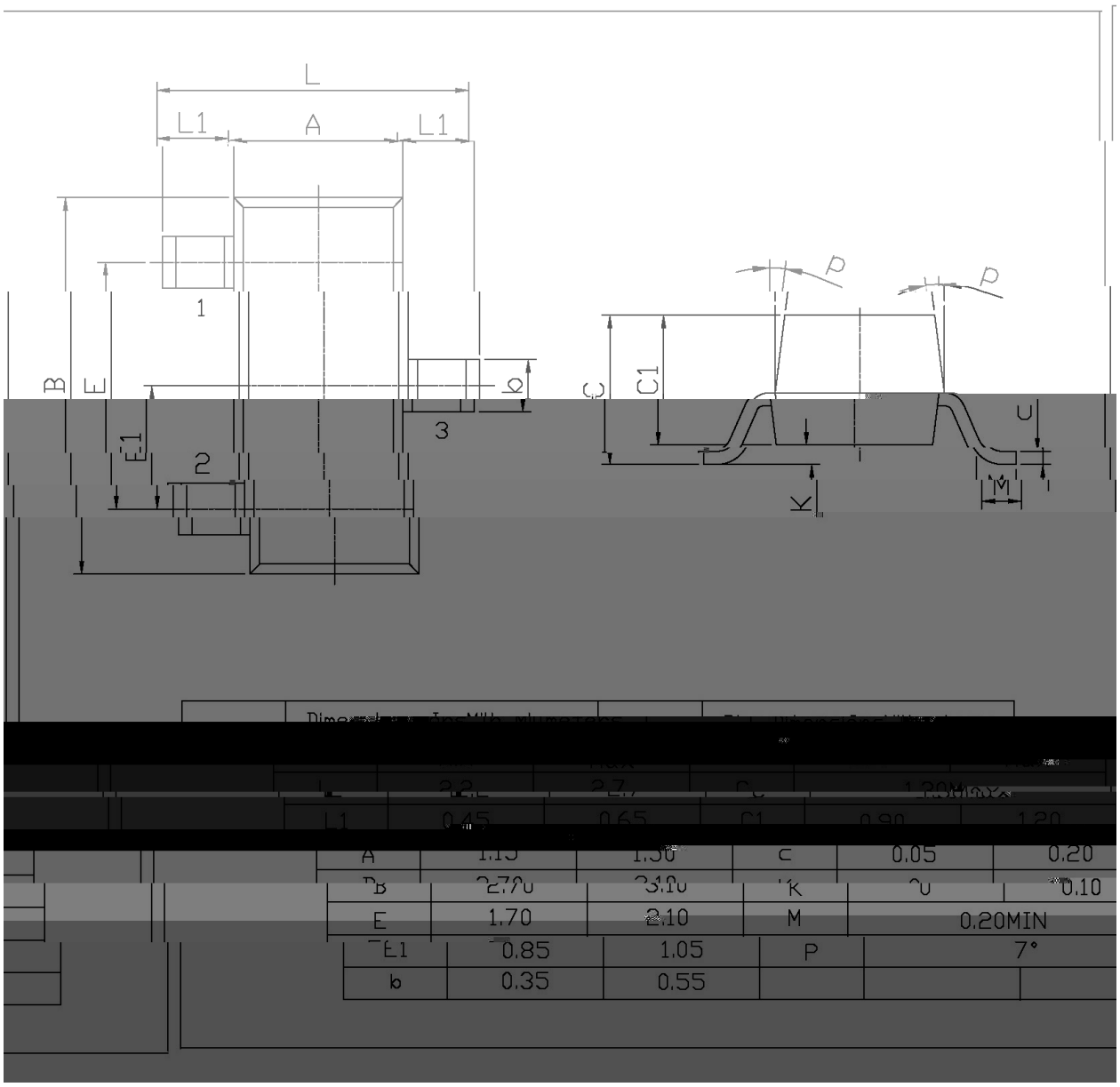
$V_{BE(sat)}$ – I_C

$V_{CE(sat)}$ – I_C

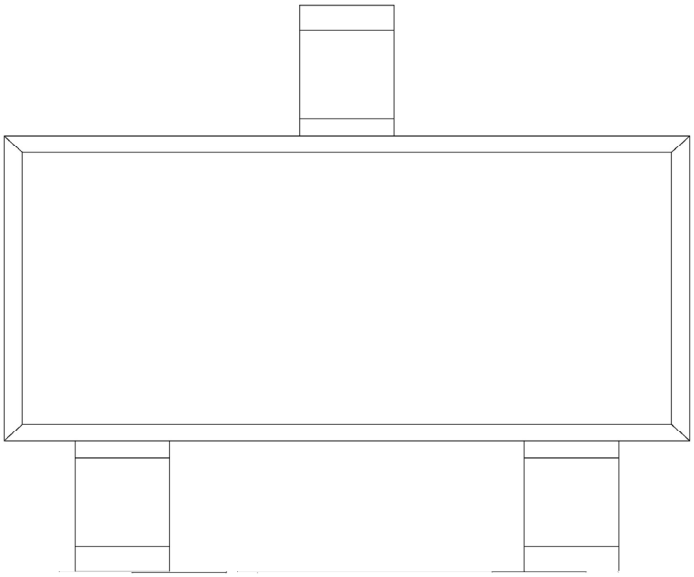


SOT-23

单位：mm



A	1.15	1.30	c	0.05	0.20
B	2.70	3.10	K	0	0.10
E	1.70	2.10	M	0.20MIN	
E1	0.85	1.05	P	7°	
b	0.35	0.55			

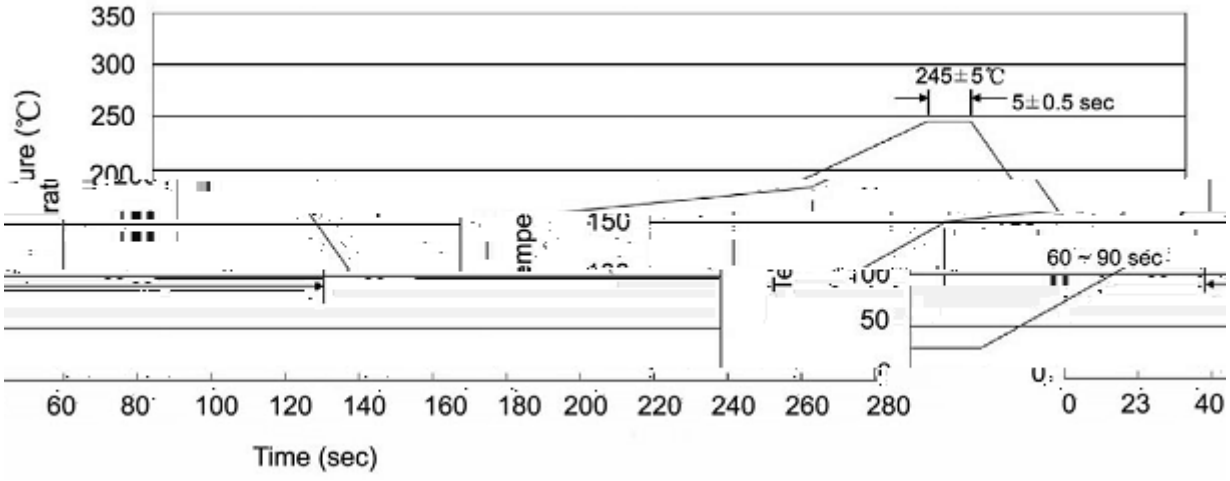


H

53

M

Temperature Profile for IR Reflow Soldering(Pb-Free)



± ± ± ±

± ±

封装形式	包装数量					包装尺寸 :		
	Units/Reel 只/卷盘	Reels/Inner Box 卷盘/盒	Units/Inner Box 只/盒	Inner Boxes/Outer Box 盒/箱	Units/Outer Box 只/箱	Reel	Inner Box 盒	Outer Box 箱
SOT-23	3,000	10	30,000	8	180,000	7 ×8	180×120×180	390×385×205